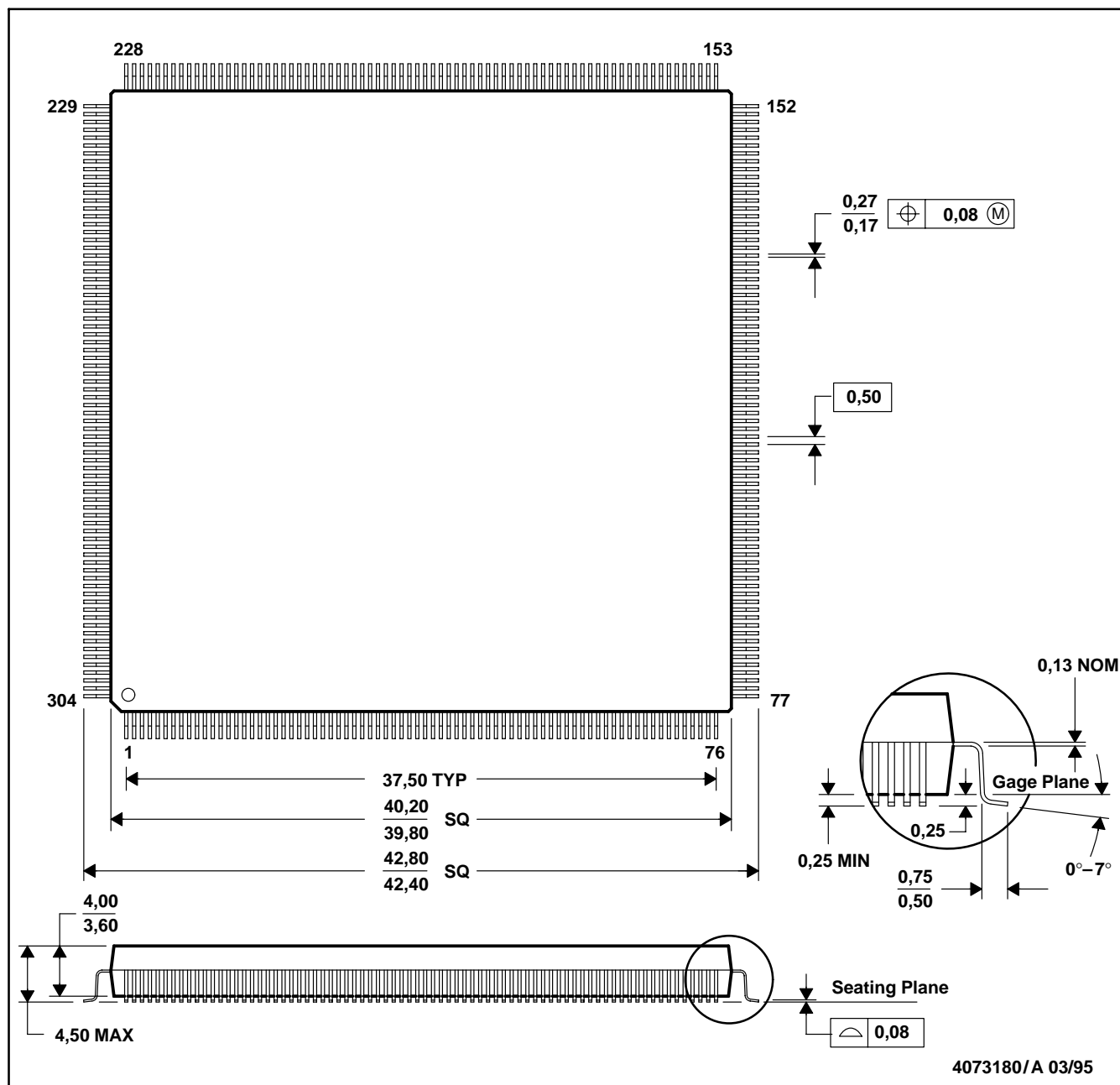


PDN (S-PQFP-G304)

PLASTIC QUAD FLATPACK (DIE-DOWN)



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Falls within JEDEC MO-143

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